

General Description

FSMOS[®]

$R_{DS(ON)}$, low gate charge, fast switching and excellent avalanche characteristics. The low V_{th} series is specially optimized for synchronous rectification systems with low driving voltage.

Features

- Low $R_{DS(ON)}$ & FOM
- Extremely low switching loss
- Excellent reliability and uniformity
- Fast switching and soft recovery

Applications

- PD charger
- Motor driver
- Switching voltage regulator
- DC-DC convertor
- Switched mode power supply

Key Performance Parameters

| Parameter | Value | Unit |
|--------------------------------|-------|------|
| $V_{DS, min} @ T_{j(max)}$ | 60 | V |
| $I_D, pulse$ | 210 | A |
| $R_{DS(ON), max} @ V_{GS}=10V$ | 4.5 | |
| Q_g | 30 | nC |

Marking Information

| Product Name | Package |
|--------------|---------|
|--------------|---------|

Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ unless otherwise noted

| Parameter | Symbol | Value | Unit |
|-------------------------------------------------------------------------|----------------------|------------|------------------|
| Drain-source voltage | V_{DS} | 60 | V |
| Gate-source voltage | V_{GS} | ± 20 | V |
| Continuous drain current ¹⁾ , $T_C=25^\circ\text{C}$ | I_D | 70 | A |
| Pulsed drain current ²⁾ , $T_C=25^\circ\text{C}$ | $I_{D,\text{pulse}}$ | 210 | A |
| Continuous diode forward current ¹⁾ , $T_C=25^\circ\text{C}$ | I_S | 70 | A |
| Diode pulsed current ²⁾ , $T_C=25^\circ\text{C}$ | $I_{S,\text{pulse}}$ | 210 | A |
| Power dissipation ³⁾ , $T_C=25^\circ\text{C}$ | P_D | 101 | W |
| Single pulsed avalanche energy ⁵⁾ | E_{AS} | 66 | mJ |
| Operation and storage temperature | T_{stg}, T_j | -55 to 150 | $^\circ\text{C}$ |

Thermal Characteristics

| Parameter | Symbol | Value | Unit |
|----------------------------------------------------|--------|-------|---------------------------|
| Thermal resistance, junction-case | R | 1.24 | $^\circ\text{C}/\text{W}$ |
| Thermal resistance, junction-ambient ⁴⁾ | R | 62 | $^\circ\text{C}/\text{W}$ |

Electrical Characteristics at $T_j=25^\circ\text{C}$ unless otherwise specified

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test condition |
|----------------------------------|---------------------|------|------|------|------|-------------------------------------------|
| Drain-source breakdown voltage | BV_{DSS} | 60 | | | V | $V_{GS}=0 \text{ V}, I_D=250 \text{ A}$ |
| Gate threshold voltage | $V_{GS(\text{th})}$ | 1.0 | | 2.5 | V | $V_{DS}=V_{GS}, I_D=250 \text{ A}$ |
| Drain-source on-state resistance | $R_{DS(\text{ON})}$ | | 3.5 | 4.5 | | $V_{GS}=10 \text{ V}, I_D=20 \text{ A}$ |
| Drain-source on-state resistance | $R_{DS(\text{ON})}$ | | 4.5 | 7 | | $V_{GS}=4.5 \text{ V}, I_D=10 \text{ A}$ |
| Gate-source leakage current | I_{GSS} | | | 100 | nA | $V_{GS}=20 \text{ V}$ |
| | | | | -100 | | $V_{GS}=-20 \text{ V}$ |
| Drain-source leakage current | I_{DSS} | | | 1 | A | $V_{DS}=60 \text{ V}, V_{GS}=0 \text{ V}$ |
| Gate Resistance | R_G | | 2.8 | | | |

Dynamic Characteristics

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test condition |
|------------------------------|--------------|------|------|------|------|------------------------------------------------------------------------------|
| Input capacitance | C_{iss} | | 2136 | | pF | $V_{GS}=0\text{ V},$ $V_{DS}=50\text{ V},$ Hz |
| Output capacitance | C_{oss} | | 332 | | pF | |
| Reverse transfer capacitance | C_{rss} | | 10.6 | | pF | |
| Turn-on delay time | $t_{d(on)}$ | | 22.9 | | ns | $V_{GS}=10\text{ V},$ $V_{DS}=50\text{ V},$ R_G $I_D=25\text{ A}$ |
| Rise time | t_r | | 6.5 | | ns | |
| Turn-off delay time | $t_{d(off)}$ | | 45.7 | | ns | |
| Fall time | t_f | | | | | |

Electrical Characteristics Diagrams

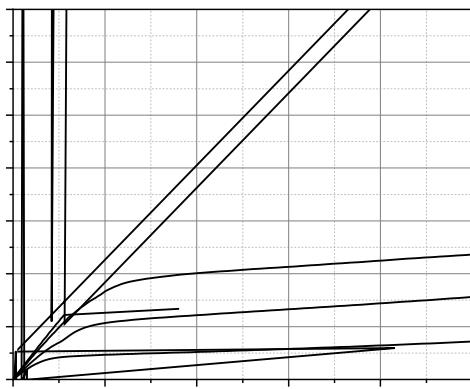


Figure 1. Typ. output characteristics

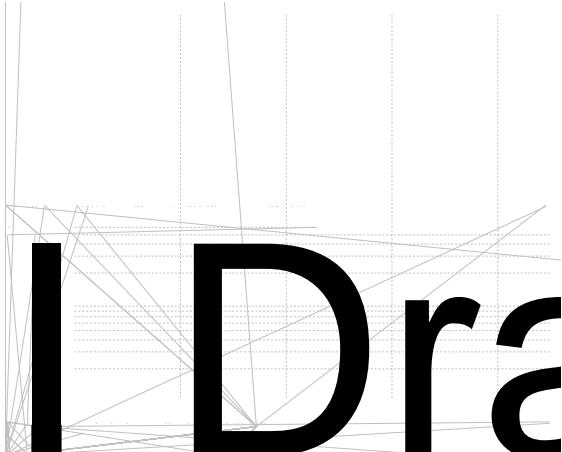


Figure 2. Typ. transfer characteristics

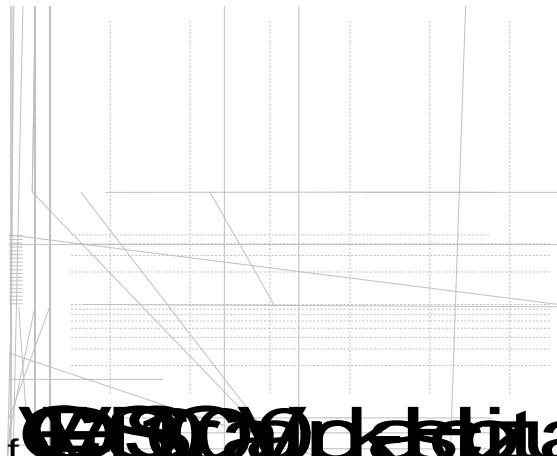


Figure 3. Typ. capacitances

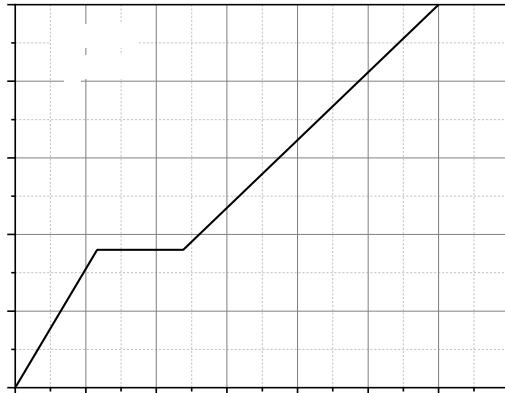


Figure 4. Typ. gate charge

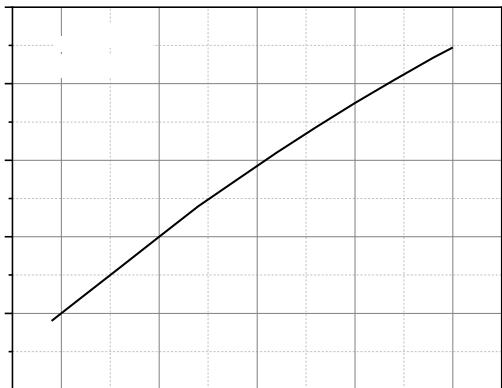


Figure 5. Drain-source breakdown voltage

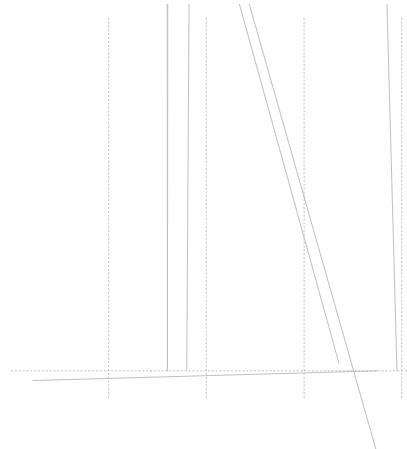
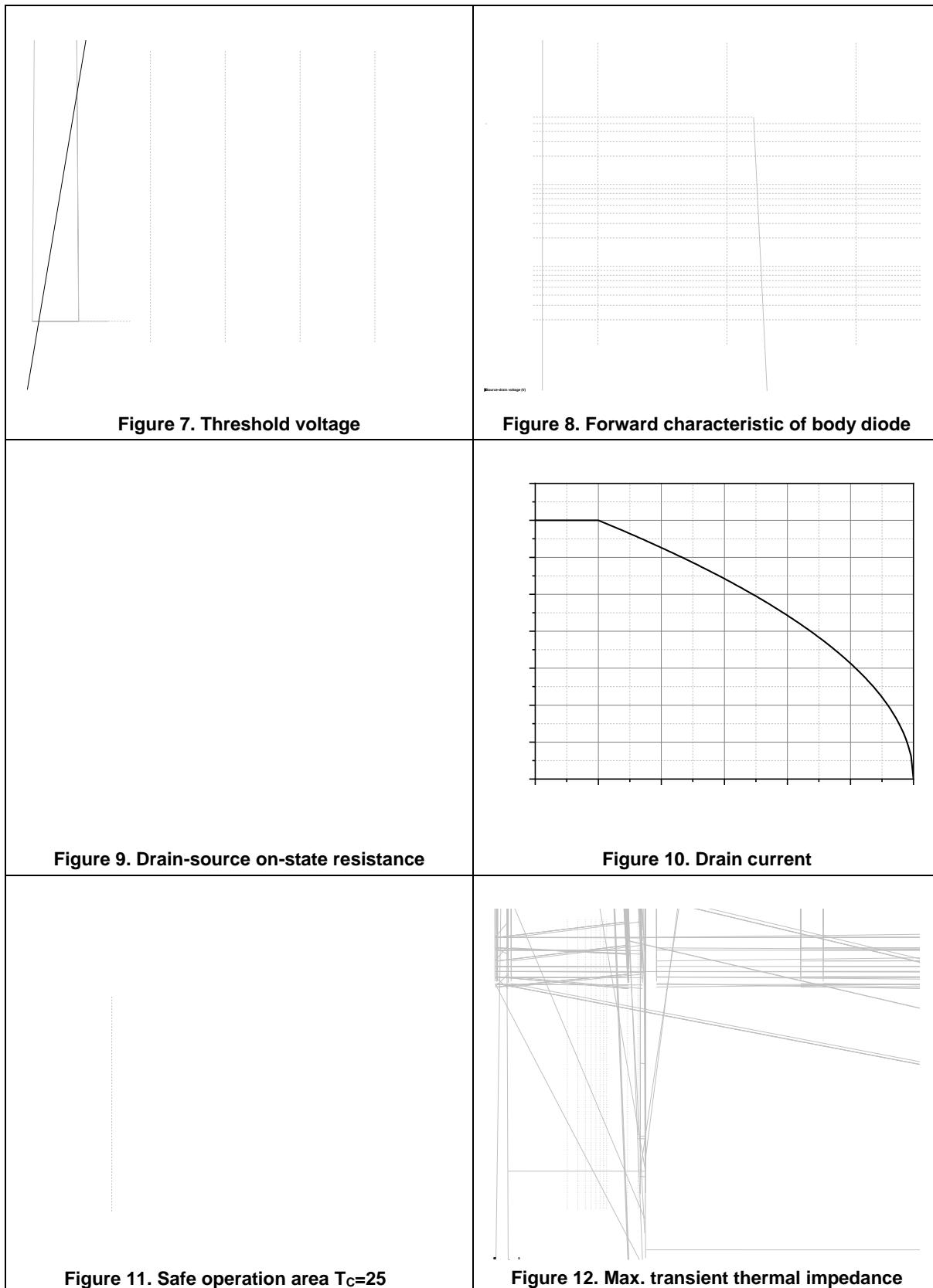


Figure 6. Drain-source on-state resistance



Test circuits and waveforms

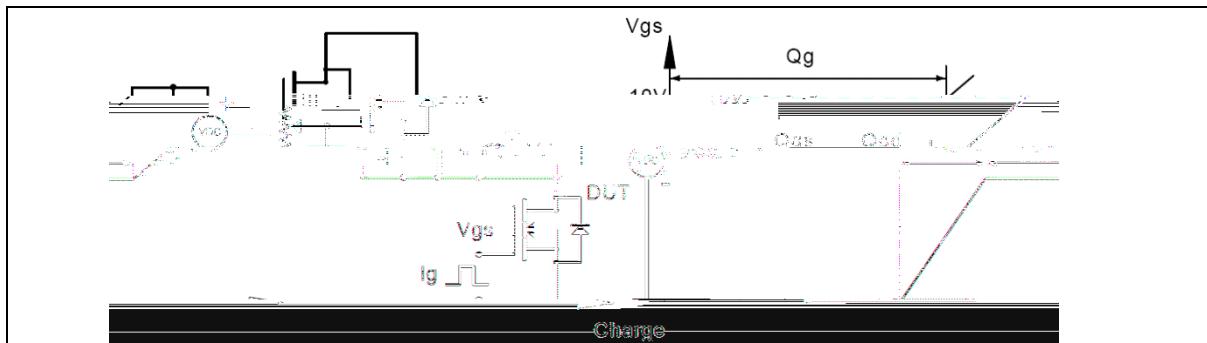


Figure 1. Gate charge test circuit & waveform

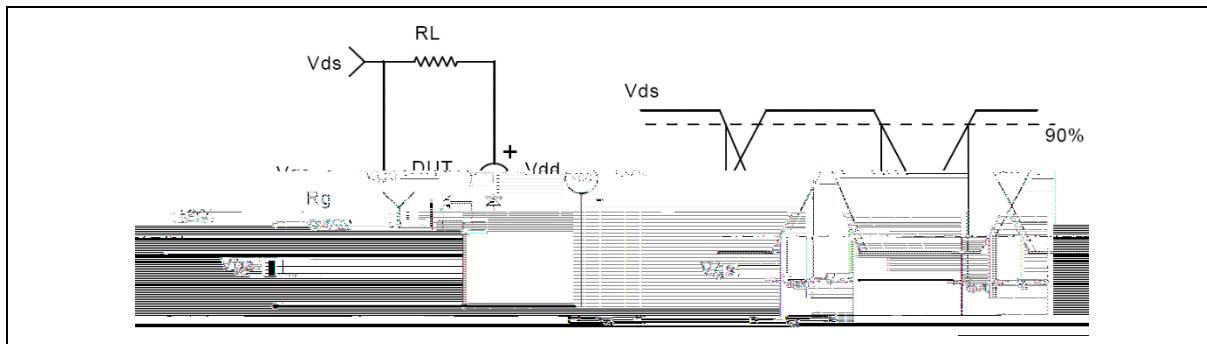


Figure 2. Switching time test circuit & waveform

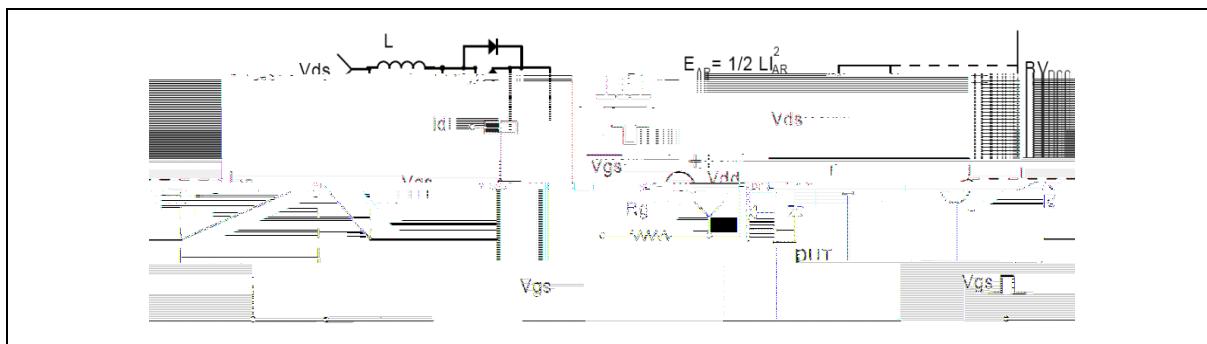


Figure 3. Unclamped inductive switching (UIS) test circuit & waveform

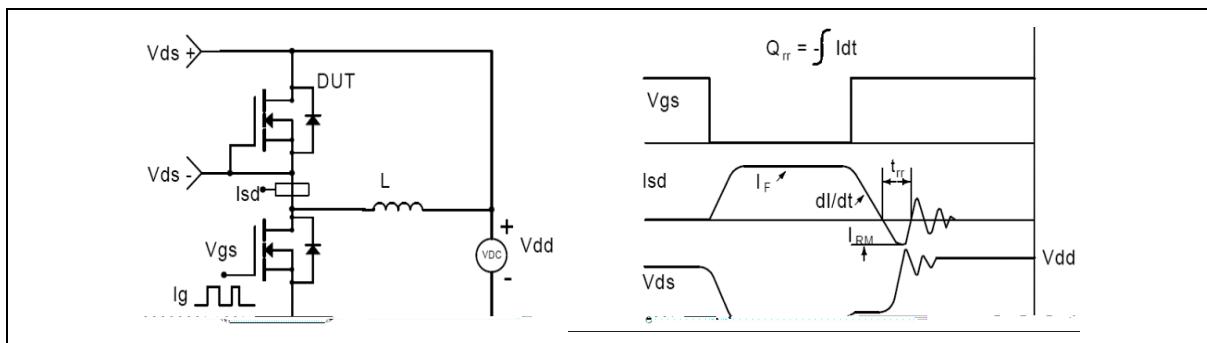
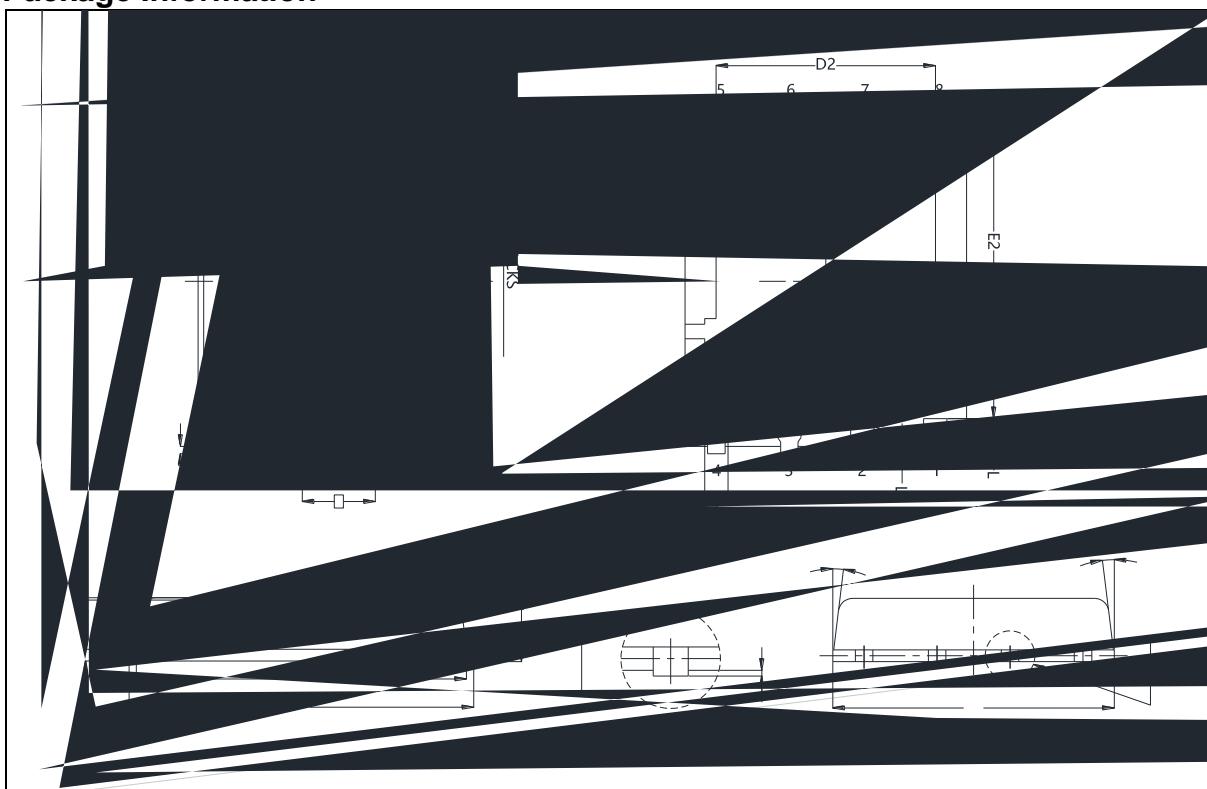


Figure 4. Diode reverse recovery test circuit & waveform

Package Information



| Symbol | mm | | |
|--------|----------|------|------|
| | Min | Nom | Max |
| A | 0.90 | 1.00 | 1.10 |
| A1 | 0.00 | - | 0.05 |
| b | 0.33 | 0.41 | 0.51 |
| C | 0.20 | 0.25 | 0.30 |
| D1 | 4.80 | 4.90 | 5.00 |
| D2 | 3.61 | 3.81 | 3.96 |
| E | 5.90 | 6.00 | 6.10 |
| E1 | 5.70 | 5.75 | 5.80 |
| E2 | 3.38 | 3.58 | 3.78 |
| e | 1.27 BSC | | |
| H | 0.41 | 0.51 | 0.61 |
| K | 1.10 | - | - |
| L | 0.51 | 0.61 | 0.71 |
| L1 | 0.06 | 0.13 | 0.20 |
| | 0° | - | 12° |

Version 1: PDFN5*6-M package outline dimension

Ordering Information

| Package Type | Units/Reel | Reels/Inner Box | Units/Inner Box | Inner Boxes/Carton Box | Units/Carton Box |
|--------------|------------|-----------------|-----------------|------------------------|------------------|
| PDFN5*6-M | 5000 | 2 | 10000 | 5 | 50000 |

Product Information

| Product | Package | Pb Free | RoHS |
|---------|---------|---------|------|
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